High Current Molded Power Inductor - PA4343.XXXANLT Series







e Height: 6.5mm Max

*Footprint:* 14.0mm x 12.8mm Max

- *Current Rating:* up to 53A
- Inductance Range: 0.22uH to 68uH
- Shielded construction and compact design
- Ø High current, low DCR, and high efficiency
- Ø Minimized acoustic noise and minimized leakage flux
- @ 200 Vdc Isolation between terminal and core

Electrical Specifications @ 25°C - Operating Temperature -55°C to +155°C       Saturation <sup>2</sup> Saturation <sup>2</sup> Current     SRF									
Part Number	100KHz, 1V	Current	TYP.	MAX.	TYP.	TYP.	Mechanical	K Factor	
	uH±20%	A	mΩ	mΩ	A	MHz			
PA4343.221ANLT	0.22	42	0.4	0.46	105	130	Footprint 1	93.5	
PA4343.331ANLT	0.33	36	0.6	0.70	65	80	Footprint 1	106.1	
PA4343.471ANLT	0.47	35	0.88	1.02	58	70	Footprint 1	60.4	
PA4343.561ANLT	0.56	33.5	1.1	1.3	50	62	Footprint 1	60.4	
PA4343.681ANLT	0.68	33	1.25	1.5	46	58	Footprint 1	75.8	
PA4343.821ANLT	0.82	31	1.3	1.65	39	56	Footprint 1	68.7	
PA4343.102ANLT	1.0	29	1.5	1.8	36	43	Footprint 1	53.5	
PA4343.152ANLT	1.5	25	2.2	2.53	30	33	Footprint 1	38.1	
PA4343.222ANLT	2.2	21	3.7	4.2	24	25	Footprint 2	32.2	
PA4343.242ANLT	2.4	20.5	3.9	4.5	23.5	23	Footprint 2		
PA4343.332ANLT	3.3	19	5.3	6.2	22.5	17	Footprint 2	22.6	
PA4343.472ANLT	4.7	17	6.8	8.0	21	15	Footprint 2	16.5	
PA4343.562ANLT	5.6	15	8.3	9.8	19.5	14	Footprint 2	16.5	
PA4343.682ANLT	6.8	14	9.8	11.3	18	12	Footprint 2	12.0	
PA4343.822ANLT	8.2	12.5	12	13.8	17	10	Footprint 2	11.0	
PA4343.103ANLT	10	11	13	15.8	15	10	Footprint 2	10.1	
PA4343.223ANLT	22	8	31	35	9	6	Footprint 2	8.6	
PA4343.333ANLT	33	6.5	46	55	8	4	Footprint 2	5.1	
PA4343.473ANLT	47	5.7	58	67	6.8	4	Footprint 2	6.2	
PA4343.683ANLT	68	4.8	82	100	5.0	3	Footprint 2	4.7	

High Current Molded Power Inductor - PA4343.XXXANLT Series

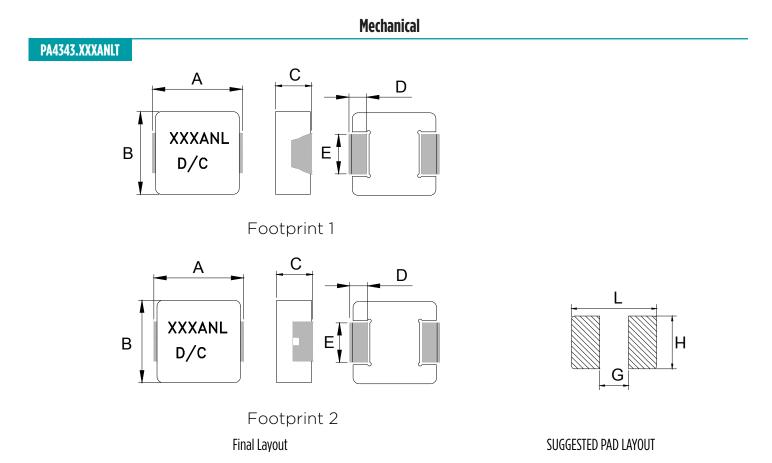
# Pulse a YAGEO company

#### Notes:

- 1. Actual temperature of the component during system operation (ambient plus temperature rise) must be within the standard operating range.
- The saturation current is the current at which the initial inductance drops by approximately 30% at the stated ambient temperature. The maximum allowable drop at this stated current is 40% of the initial inductance. This current is determined by placing the component in the specified ambient environment and applying a short duration pulse current (to eliminate self-heating effect) to the component.
- 3. The rated current is the DC current required to raise the component temperature by approximately 40°C. Take note that the components' performanc varies depending on the system condition. It is suggested that the component be tested at the system level, to verify the temperature rise of the component during system operation.
- 4. The part temperature (ambient+temp rise) should not exceed maximum operating 8. temperature under worst case operating conditions. Circuit design, PCB trace size and

thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

- Please note that the inductance tolerance of all parts are ±20%, except those indicated by an \* which are +/- 30%.
- Parts shown in bold are standard catalog parts and are available through sample stock and distribution. Parts in lighter font are available but are not necessarily held in sample stock or distribution and lead times may be longer. Please contact Pulse for availablity.
- The mechanical dimensions are 100% tested in production but do not necessarily meet a product capability index (Cpk) 1.33 and therefore may not strictly conform to PPAP.
  - Special Characteristics 💭



7.

Series	Mechanical	A	В	C	D	E	L	G	Н
PA4343.XXXANLT	Footprint 1	13.5±0.5	12.6±0.2	6.2±0.3	1.1±0.3	4.0±0.3	14.5	8.0	5.0
PA4343.XXXANLT	Footprint 2	13.5±0.5	12.6±0.2	6.2±0.3	1.1±0.3	4.7±0.3	14.5	8.0	5.0

All Dimensions in mm.

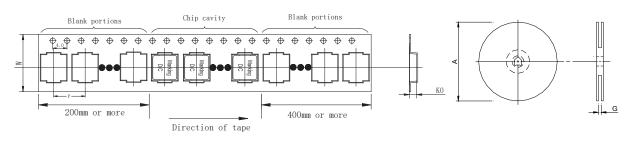
0

Type A(mm) B(mm) C(mm) D(mm)

High Current Molded Power Inductor - PA4343.XXXANLT Series 55.5.2

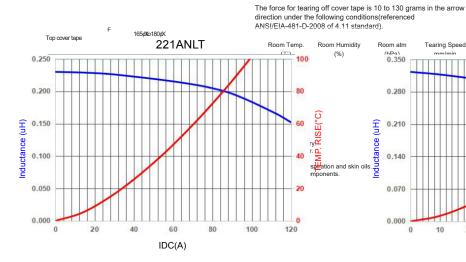


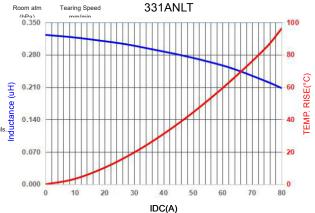
#### **TAPE & REEL INFO**

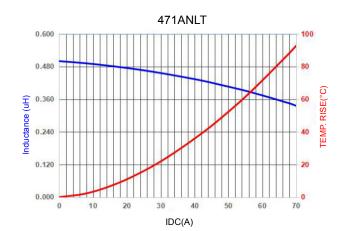


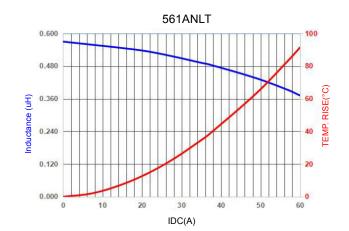
Series S	Size	Bo(mm) A	o(mm) Ko(mm)	P(mm)	W(mm)	F(mm)	t(mm)	D(mm)				
TMPA 1	1265	14.1±0.1 1	SURFACE MOUNTING TYPE, REEL/TAPE LIST									
			RE	EL SIZE	(mm)		TAPE SIZE (mm)			QTY		
					ļ	1	G	P <sub>1</sub>		W	K <sub>o</sub>	PCS/REEL
TMP Chip / F		1265	PA4343.XX	XANLT	Ø3	30	24.4	16		24	7.0	500
Inner b	box											

#### **Typical Performance Curves**



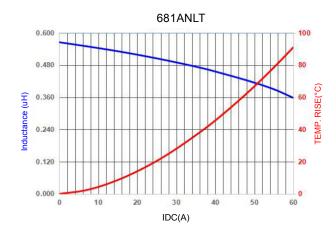


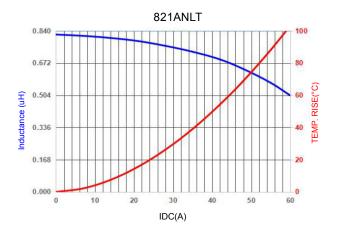


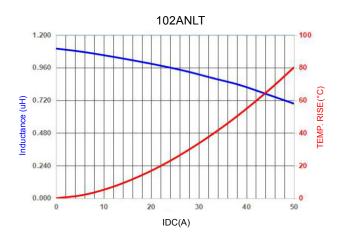


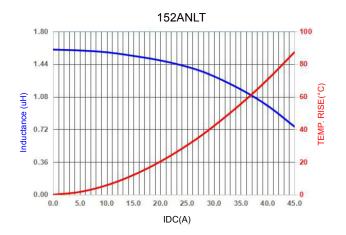
High Current Molded Power Inductor - PA4343.XXXANLT Series

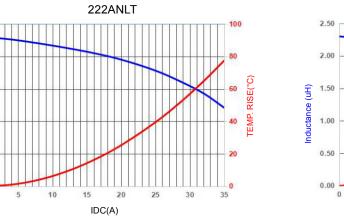


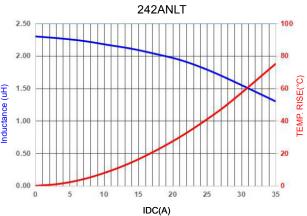












4

2.50

2.00

1.50

1.00

0.50

0.00

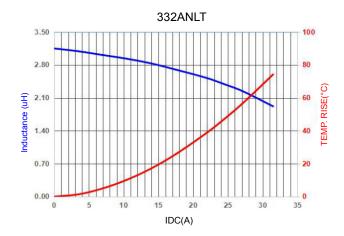
0

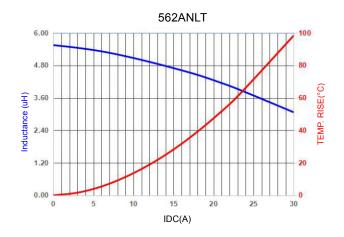
Inductance (uH)

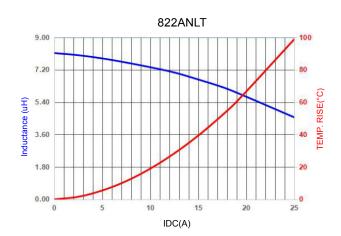
PulseElectronics.com

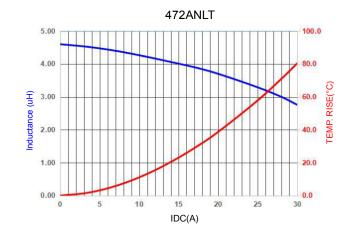
High Current Molded Power Inductor - PA4343.XXXANLT Series

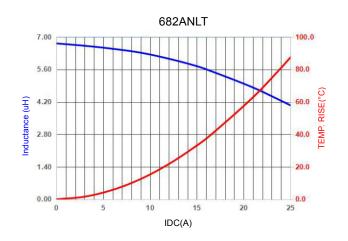


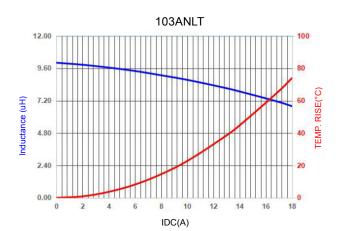








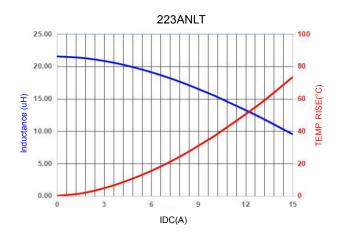


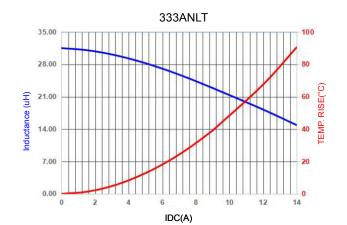


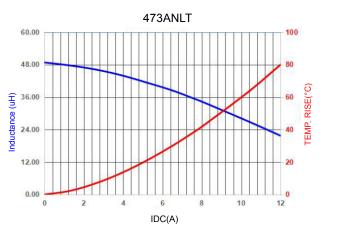
5

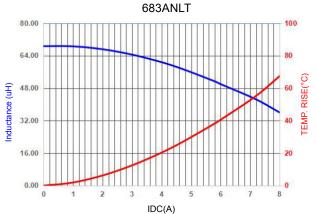
High Current Molded Power Inductor - PA4343.XXXANLT Series





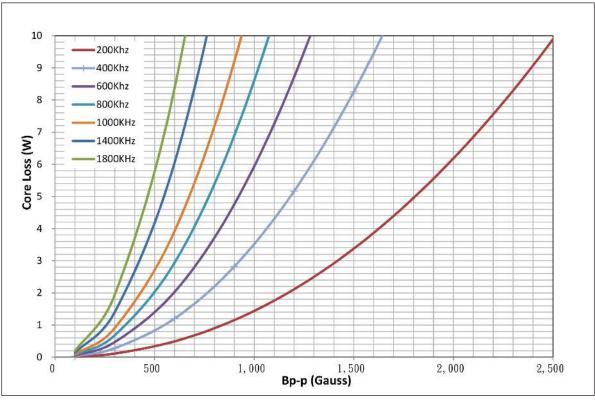






High Current Molded Power Inductor - PA4343.XXXANLT Series

#### **Core Loss**



Bp-p = K \*L(uH) \*delta I(A)

#### For More Information:

Americas - prodinfo\_power\_americas@yageo.com | Europe - prodinfo\_power\_emea@yageo.com | Asia - prodinfo\_power\_asia@yageo.com

Performance warranty of products offered on this data sheet is limited to the parameters specified. Data is subject to change without notice. Other brand and product names mentioned herein may be trademarks or registered trademarks of their respective owners. © Copyright, 2023. Pulse Electronics, Inc. All rights reserved.

YAGEO Corporation and its affiliates do not recommend the use of commercial or automotive grade products for high reliability applications or manned space flight.

7

PulseElectronics.com

